nuvoTon

ARM Cortex™-M0

32-BIT MICROCONTROLLER

NuMicro Mini51™ DE Series Product Brief

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1 GENERAL DESCRIPTION

The NuMicro Mini51™ series 32-bit microcontroller is embedded with ARM® Cortex™-M0 core for industrial control and applications which require high performance, high integration, and low cost. The Cortex™-M0 is the newest ARM® embedded processor with 32-bit performance at a cost equivalent to the traditional 8-bit microcontroller.

The NuMicro Mini51™ series can run up to 24 MHz and operate at 2.5V ~ 5.5V, -40℃ ~ 105℃, and thus can afford to support a variety of industrial control and applications which need high CPU performance. The NuMicro Mini51™ series offers 4K/8K/16K-bytes embedded program flash, size configurable data flash (shared with program flash), 2K-byte flash for the ISP, and 2K-byte SRAM.

Many system level peripheral functions, such as I/O Port, Timer, UART, SPI, I^2C, PWM, ADC, Watchdog Timer, Analog Comparator and Brown-out Detector, have been incorporated into the NuMicro Mini51™ series in order to reduce component count, board space and system cost. These useful functions make the NuMicro Mini51™ series powerful for a wide range of applications.

Additionally, the NuMicro Mini51™ series is equipped with ISP (In-System Programming) and ICP (In-Circuit Programming) functions, which allow the user to update the program memory without removing the chip from the actual end product.

2 FEATURES

- Core
  - ARM® Cortex™-M0 core running up to 24 MHz
  - One 24-bit system timer
  - Supports Low Power Sleep mode
  - A single-cycle 32-bit hardware multiplier
  - NVIC for the 32 interrupt inputs, each with 4-level of priority
  - Supports Serial Wire Debug (SWD) interface and two watch points/four breakpoints
- Built-in LDO for wide operating voltage ranged: 2.5 V to 5.5 V
- Memory
  - 4 KB/ 8 KB/ 16 KB Flash memory for program memory (APROM)
  - Configurable Flash memory for data memory (Data Flash)
  - 2 KB Flash for loader (LDROM)
  - 2 KB SRAM for internal scratch-pad RAM (SRAM)
- Clock Control
  - Programmable system clock source
    - Switch clock sources on-the-fly
  - 4 ~ 24 MHz external crystal input (HXT)
  - 32.768 kHz external crystal input (LXT) for Power-down wake-up and system operation clock
  - 22.1184 MHz internal oscillator (HIRC) (1% accuracy at 25°C, 5V)
    - Dynamically calibrating the HIRC OSC to 22.1184 MHz ±1% from -40°C to 105°C by external 32.768K crystal oscillator (LXT)
  - 10 kHz internal low-power oscillator (LIRC) for Watchdog Timer and Power-down wake-up
- I/O Port
  - Up to 30 general-purpose I/O (GPIO) pins for LQFP-48 package
  - Four I/O modes:
    - Input-only with high impendence
    - Push-pull output
    - Open-drain output
    - Quasi-bidirectional
  - TTL/Schmitt trigger input selectable
  - I/O pin can be configured as interrupt source with edge/level setting
  - Supports high driver and high sink I/O mode
  - Configurable default I/O mode of all pins after POR
- Timer

- Provides two channel 32-bit timers. One 8-bit pre-scale counter with 24-bit up counter for each timer
- Independent clock source for each timer
- Provides One-shot, Periodic, Toggle and Continuous operation modes
- 24-bit up counter value is readable through TDR (Timer Data Register)
- Provides trigger counting/free counting/counter reset function triggered by external capture pin or internal comparator signal
- Provides event counter function
- Supports wake-up from Idle or Power-down mode

- WDT (Watchdog Timer)
  - Multiple clock sources
  - Supports wake-up from Idle or Power-down mode
  - Interrupt or reset selectable on watchdog time-out
- PWM
  - Independent 16-bit PWM duty control units with maximum six outputs
  - Supports group/synchronous/independent/ complementary modes
  - Supports One-shot or Auto-reload mode
  - Supports Edge-aligned and Center-aligned type
  - Programmable dead-zone insertion between complementary channels
  - Each output has independent polarity setting control
  - Hardware fault brake protections
  - Supports duty, period, and fault break interrupts
  - Supports duty/period trigger ADC conversion
  - Timer comparing matching event trigger PWM to do phase change
  - Supports comparator event trigger PWM to force PWM output low for current period
  - Provides interrupt accumulation function
- UART (Universal Asynchronous Receiver/Transmitters)
  - One UART device
  - Buffered receiver and transmitter, each with 16-byte FIFO
  - Optional flow control function (CTSn and RTSn)
  - Supports IrDA (SIR) function
  - Programmable baud-rate generator up to 1/16 system clock
  - Supports RS-485 function
- SPI (Serial Peripheral Interface)
  - One SPI devices
  - Supports Master/Slave mode

- Full-duplex synchronous serial data transfer
- Provides 3-wire function
- Variable length of transfer data from 8 to 32 bits
- MSB or LSB first data transfer
- Rx latching data can be either at rising edge or at falling edge of serial clock
- Tx sending data can be either at rising edge or at falling edge of serial clock
- Supports Byte Suspend mode in 32-bit transmission
- 4-level depth FIFO buffer

- I^2C
  - Supports Master/Slave mode
  - Bidirectional data transfer between masters and slaves
  - Multi-master bus (no central master)
  - Arbitration between simultaneously transmitting masters without corruption of serial data on the bus
  - Serial clock synchronization allows devices with different bit rates to communicate via one serial bus
  - Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer
  - Programmable clocks allow for versatile rate control
  - Supports 7-bit addressing mode
  - Supports multiple address recognition (four slave addresses with mask option)
  - Supports Power-down wake-up function
  - Support FIFO function
- ADC (Analog-to-Digital Converter)
  - 10-bit SAR ADC with 300K SPS
  - Up to 8-ch single-end input and one internal input from band-gap
  - Conversion started either by software trigger, PWM trigger, or external pin trigger
  - Supports conversion value monitoring (or comparison) for threshold voltage detection
- Analog Comparator
  - Two analog comparators with programmable 16-level internal voltage reference
  - Build-in CRV (comparator reference voltage)
  - Supports Hysteresis function
  - Interrupt when compared results changed
- ISP (In-System Programming) and ICP (In-Circuit Programming)
- BOD (Brown-out Detector)
  - With 4 programmable threshold levels: 4.4V/3.7V/2.7V/2.2V

- Supports Brown-out interrupt and reset option
- 96-bit unique ID
- LVR (Low Voltage Reset)
  - Threshold voltage level: 2.0V
- Operating Temperature: -40℃~105℃
- Reliability: EFT > ± 4KV, ESD HBM pass 4KV
- Packages:
  - Green package (RoHS)
  - 48-pin LQFP (7x7), 33-pin QFN (5x5) , 33-pin QFN (4x4), 20-pin TSSOP

3 PARTS INFORMATION LIST AND PIN CONFIGURATION

3.1 NuMicro Mini51™ Series Selection Code

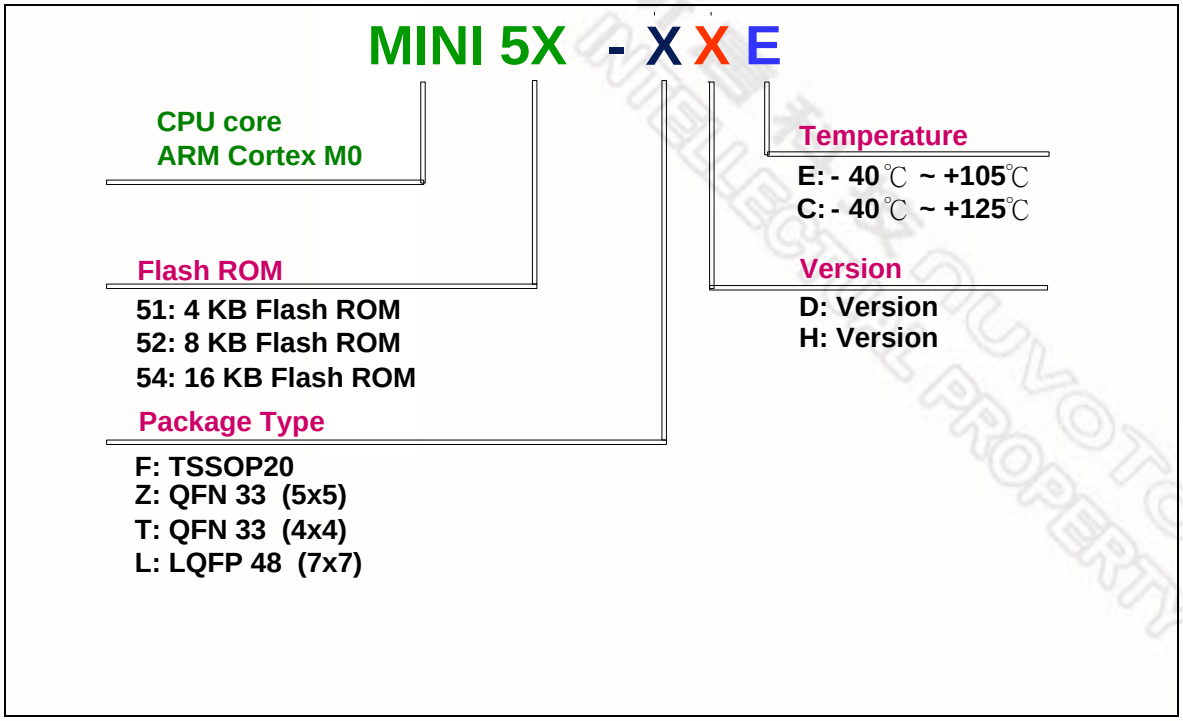


Figure 3.1-1 NuMicro Mini51™ Series Selection Code

3.2 NuMicro Mini51™ Series Product Selection Guide

Part No.	APROM	RAM	Data Flash	ISP Loader ROM	I/O	Timer	Connectivity			Comp.	PWM	ADC	ISP ICP IAP	IRC 22.1184 MHz	Package
							UART	SPI	I^2C						
MINI51FDE	4 KB	2 KB	Configurable	2 KB	up to 17	2x 32-bit	1	1	1	-	3	4x10-bit	v	v	TSSOP20
MINI51LDE	4 KB	2 KB	Configurable	2 KB	up to 30	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	LQFP48
MINI51ZDE	4 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (5x5)
MINI51TDE	4 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (4x4)
MINI52FDE	8 KB	2 KB	Configurable	2 KB	up to 17	2x 32-bit	1	1	1	-	3	4x10-bit	v	v	TSSOP20
MINI52LDE	8 KB	2 KB	Configurable	2 KB	up to 30	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	LQFP48
MINI52ZDE	8 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (5x5)
MINI52TDE	8 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (4x4)
MINI54FDE	16 KB	2 KB	Configurable	2 KB	up to 17	2x 32-bit	1	1	1	-	3	4x10-bit	v	v	TSSOP20
MINI54LDE	16 KB	2 KB	Configurable	2 KB	up to 30	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	LQFP48
MINI54ZDE	16 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (5x5)
MINI54TDE	16 KB	2 KB	Configurable	2 KB	up to 29	2x 32-bit	1	1	1	2	6	8x10-bit	v	v	QFN33 (4x4)
*MINI54FHC	16 KB	2 KB	Configurable	2 KB	up to 17	2x 32-bit	1	1	1	-	6	3x10-bit	v	v	TSSOP20

Table 3.2-1NuMicro Mini51™ Series Product Selection Guide

* Mini54FHC is a special part number, not pin to pin compatible to others Mini51series part number.

3.3 PIN CONFIGURATION

3.3.1 LQFP 48-pin

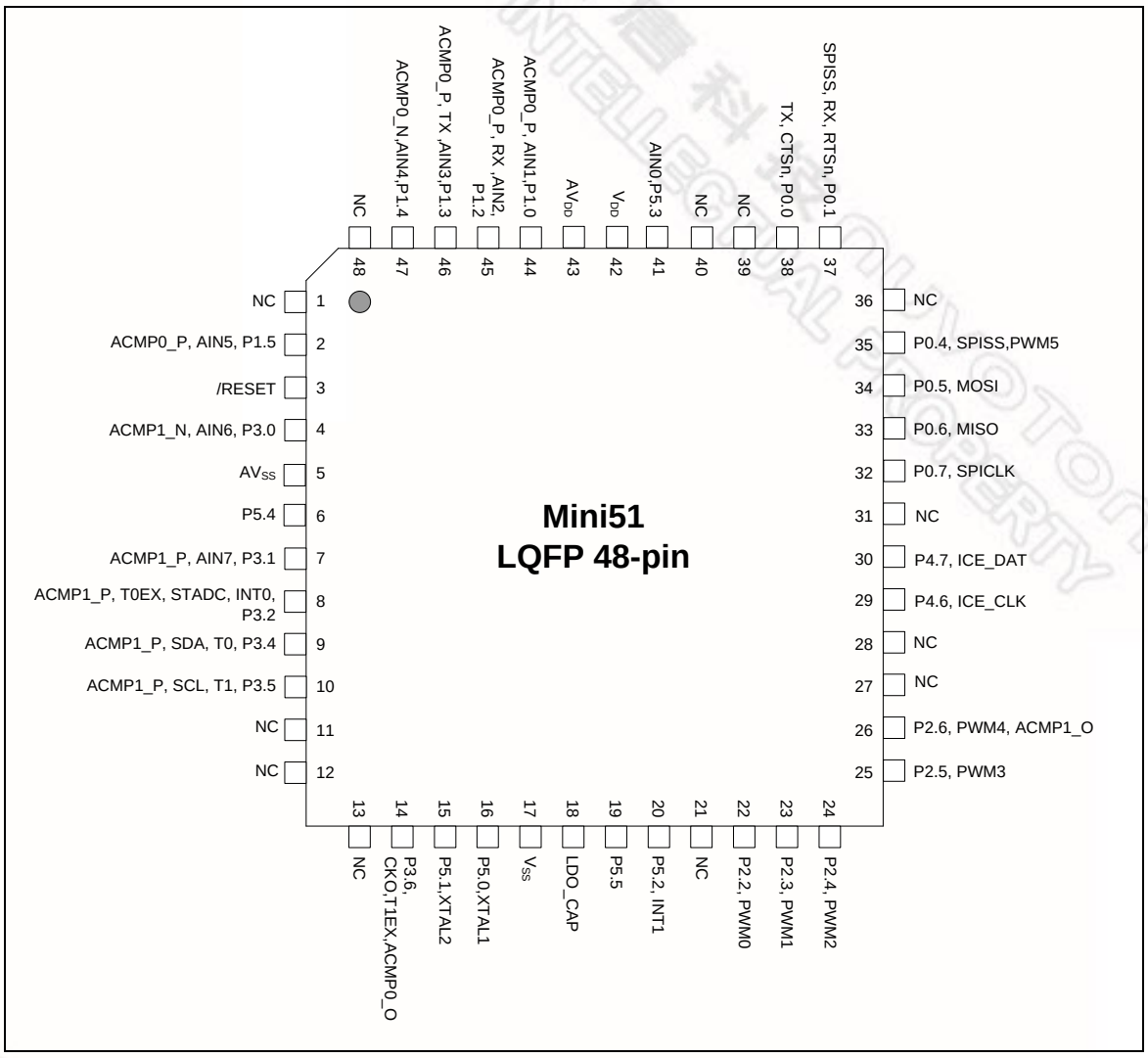


Figure 3.3-1 NuMicro Mini51™ Series LQFP 48-pin Diagram

3.3.2 QFN 33-pin

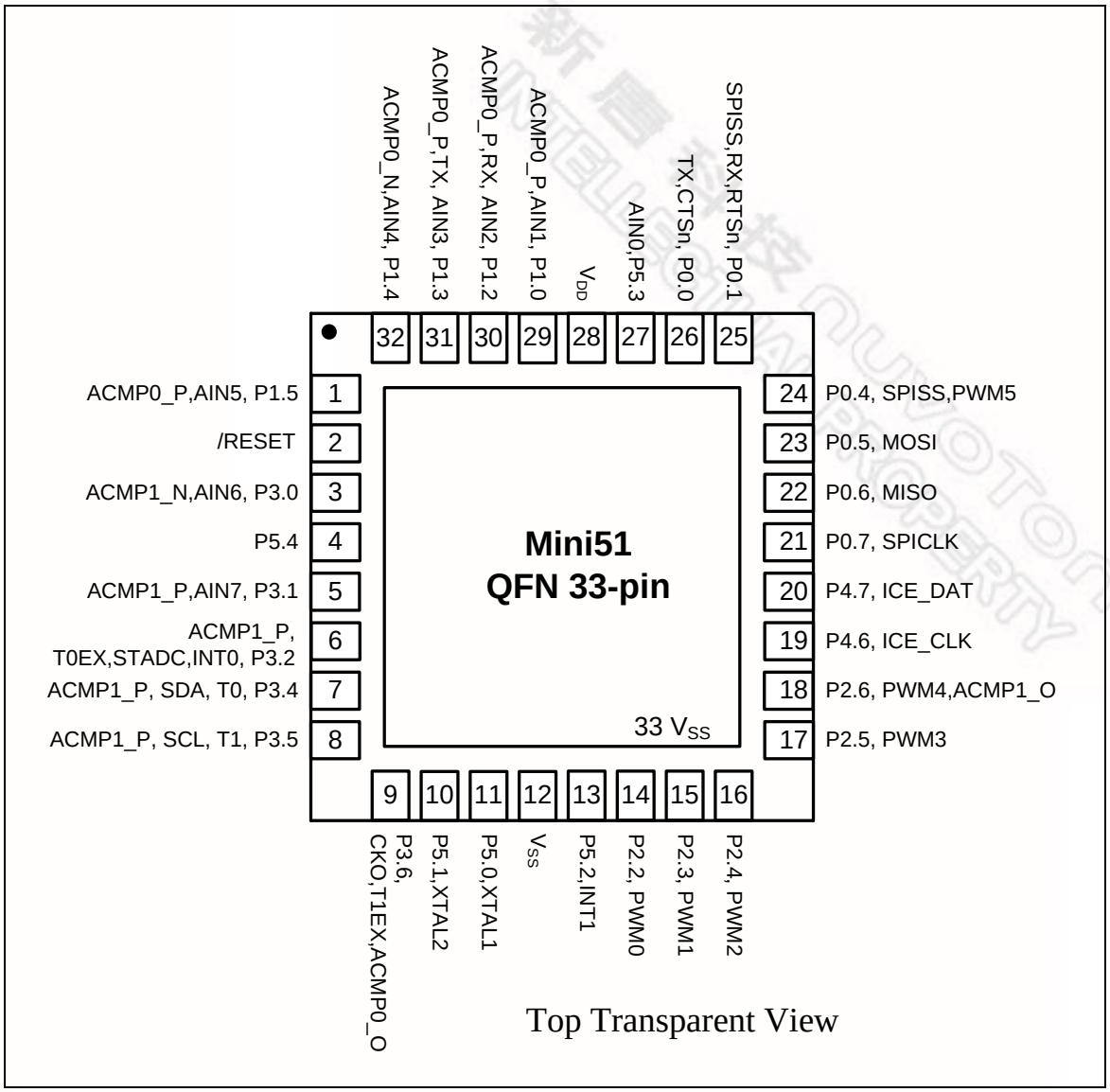


Figure 3.3-2 NuMicro Mini51™ Series QFN 33-pin Diagram

3.3.3 TSSOP 20-pin

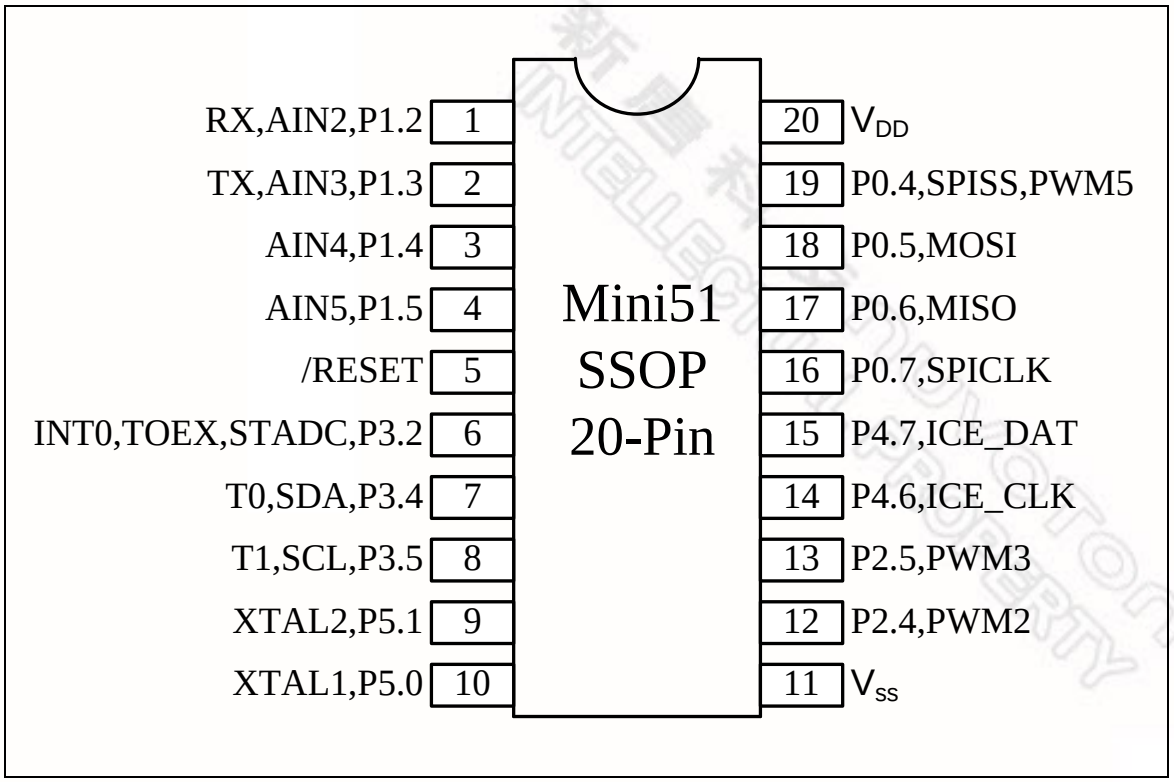


Figure 3.3-3 NuMicro Mini51™ Series TSSOP 20-pin Diagram

3.3.4 Mini54FHC (TSSOP20-pin)

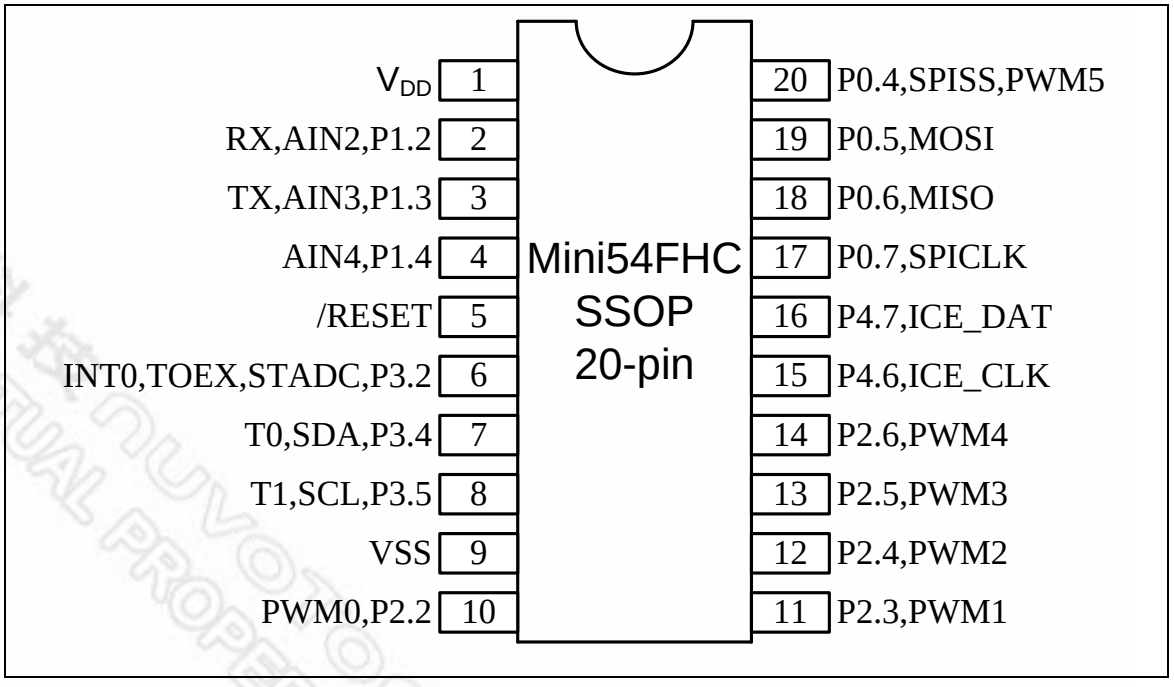


Figure 3.3-4 NuMicro Mini51™ Series TSSOP 20-pin Diagram

4 BLOCK DIAGRAM

4.1 NuMicro Mini51™ Block Diagram

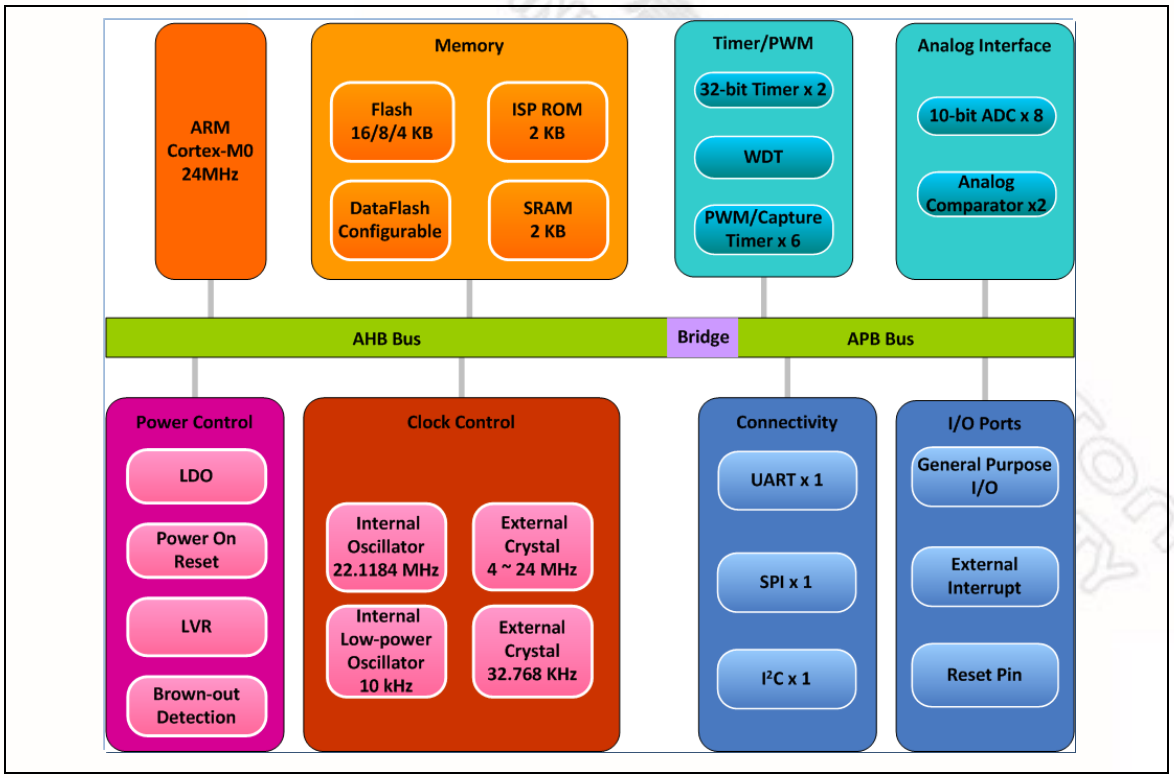
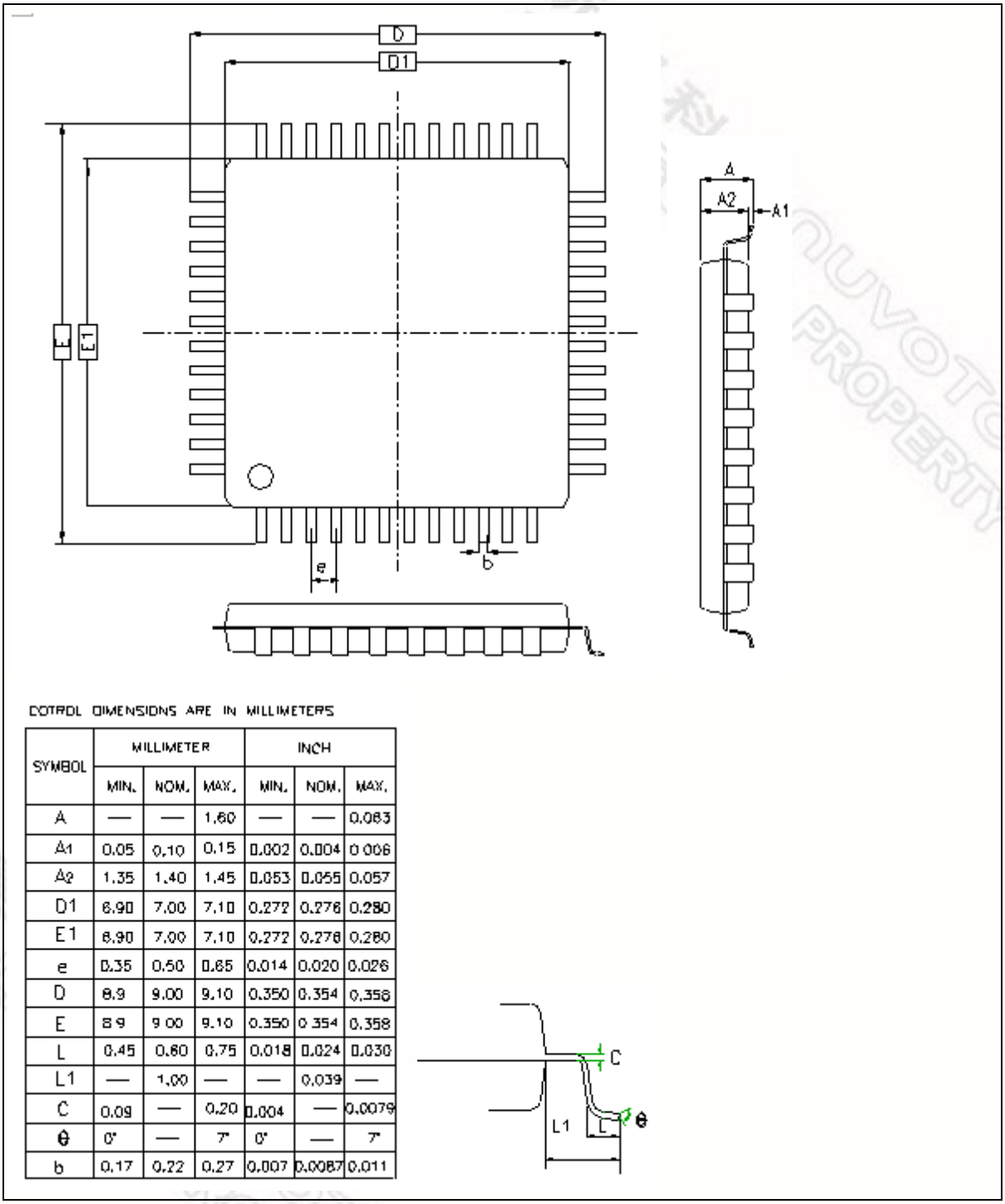


Figure 4.1-1 NuMicro Mini51™ Series Block Diagram

5 PACKAGE DIMENSIONS

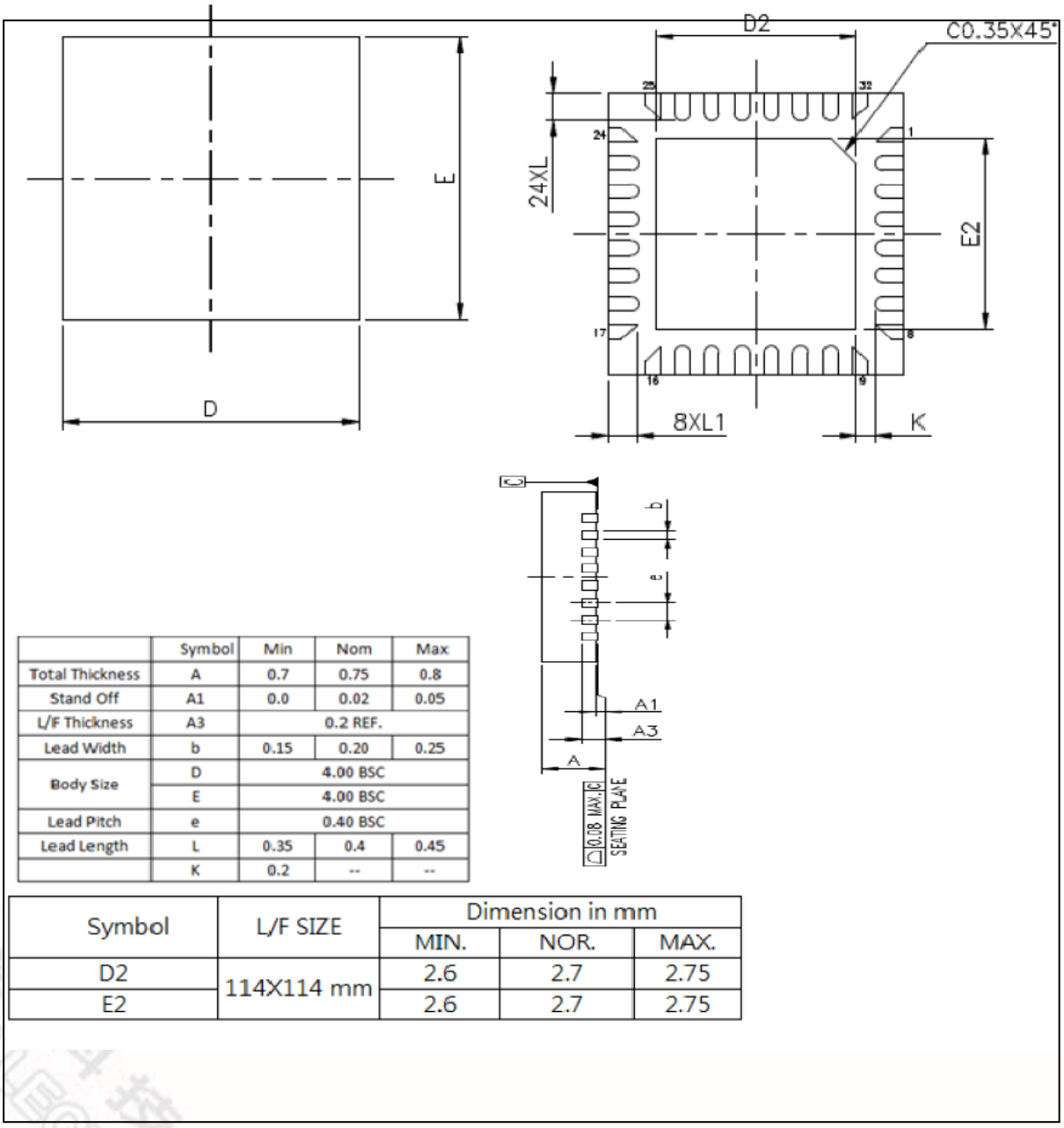
5.1 48-pin LQFP



CONTROL DIMENSIONS ARE IN MILLIMETERS

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	1.60	—	—	0.063
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D1	6.90	7.00	7.10	0.272	0.276	0.280
E1	6.90	7.00	7.10	0.272	0.276	0.280
e	0.35	0.50	0.65	0.014	0.020	0.026
D	8.9	9.00	9.10	0.350	0.354	0.358
E	8.9	9.00	9.10	0.350	0.354	0.358
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	—	1.00	—	—	0.039	—
C	0.09	—	0.20	0.004	—	0.0079
θ	0°	—	7°	0°	—	7°
b	0.17	0.22	0.27	0.007	0.0087	0.011

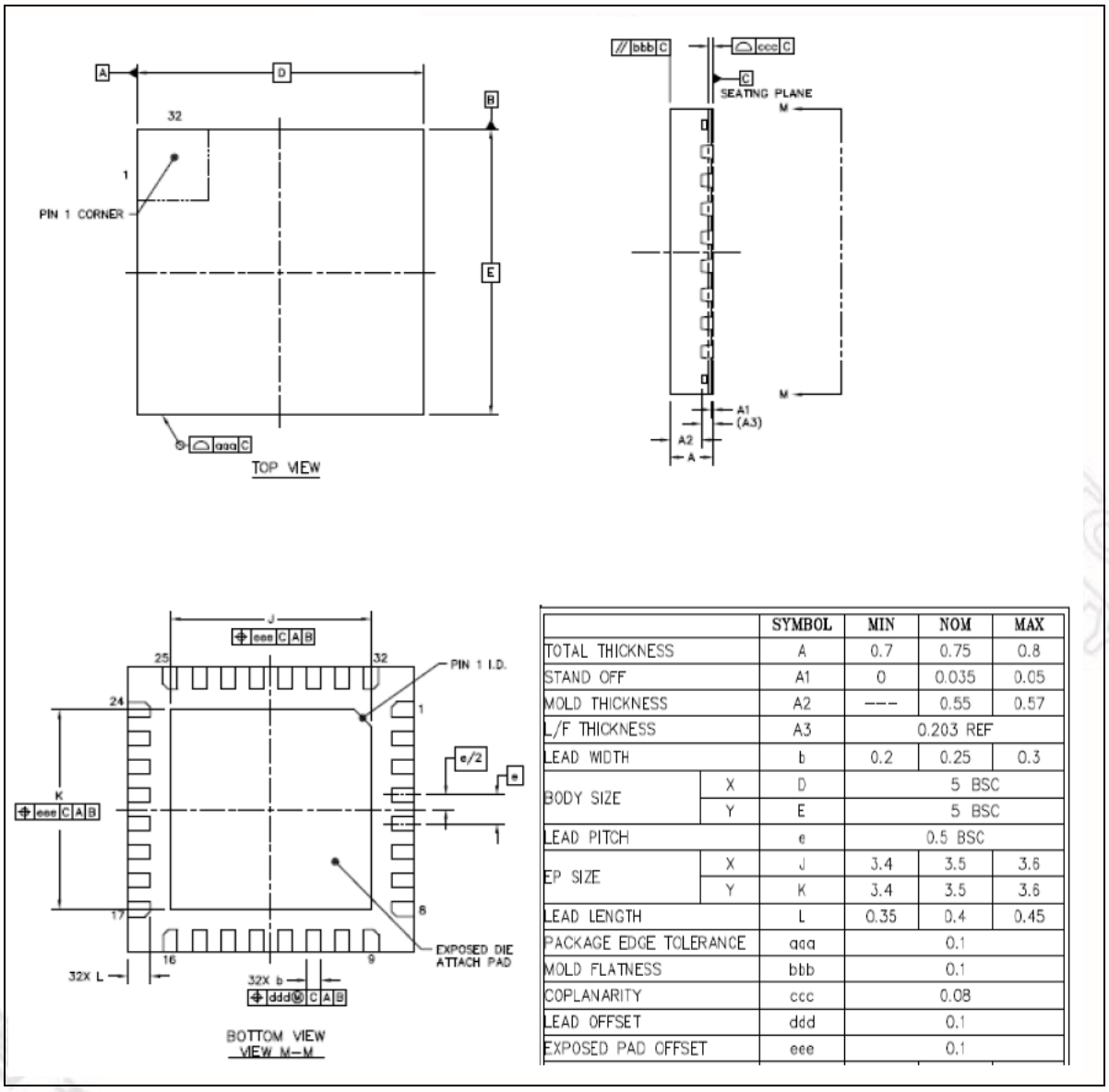
5.2 33-pin QFN (4 mm x 4 mm)



	Symbol	Min	Nom	Max
Total Thickness	A	0.7	0.75	0.8
Stand Off	A1	0.0	0.02	0.05
L/F Thickness	A3		0.2 REF.	
Lead Width	b	0.15	0.20	0.25
Body Size	D		4.00 BSC	
	E		4.00 BSC	
Lead Pitch	e		0.40 BSC	
Lead Length	L	0.35	0.4	0.45
	K	0.2	--	--

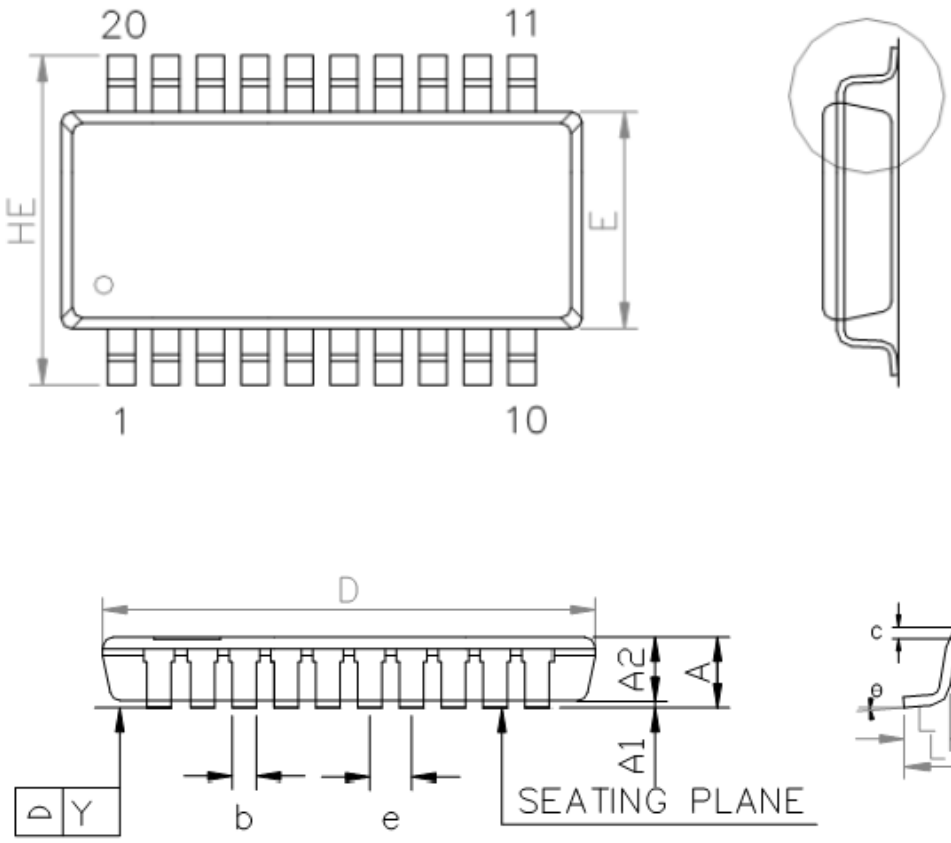
Symbol	L/F SIZE	Dimension in mm		
		MIN.	NOR.	MAX.
D2	114X114 mm	2.6	2.7	2.75
E2		2.6	2.7	2.75

5.3 33-pin QFN (5 mm x 5 mm)



		SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS		A	0.7	0.75	0.8
STAND OFF		A1	0	0.035	0.05
MOLD THICKNESS		A2	---	0.55	0.57
L/F THICKNESS		A3		0.203 REF	
LEAD WIDTH		b	0.2	0.25	0.3
BODY SIZE	X	D		5 BSC	
	Y	E		5 BSC	
LEAD PITCH		e		0.5 BSC	
EP SIZE	X	J	3.4	3.5	3.6
	Y	K	3.4	3.5	3.6
LEAD LENGTH		L	0.35	0.4	0.45
PACKAGE EDGE TOLERANCE		aaa		0.1	
MOLD FLATNESS		bbb		0.1	
COPLANARITY		ccc		0.08	
LEAD OFFSET		ddd		0.1	
EXPOSED PAD OFFSET		eee		0.1	

5.4 20-pin TSSOP



SYMBOL	DIMENSION (MM)			DIMENSION (INCH)		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	1.20	—	—	0.047
A1	0.05	—	0.15	0.002	—	0.006
A2	0.80	0.90	1.05	0.031	0.035	0.041
E	4.30	4.40	4.50	0.169	0.173	0.177
HE	6.40 BSC			0.252 BSC		
D	6.40	6.50	6.60	0.252	0.256	0.260
L	0.50	0.60	0.75	0.020	0.024	0.030
L1	1.00 REF			0.039 REF		
b	0.19	—	0.30	0.007	—	0.012
e	0.65 BSC			0.026 BSC		
c	0.09	—	0.20	0.004	—	0.008
θ	0°	—	8°	0°	—	8°
Y	0.10 BASIC			0.004 BASIC		

6 REVISION HISTORY

Revision	Date	Description
1.00	Oct. 18, 2013	Preliminary version
1.01	May 20, 2014	Supported the Mini54FHC for NuMicro Mini51 series.